# High-Speed, Rail-to-Rail Input, CMOS Comparator

#### ■ FEATURES (V+ = 5V, Typical value, Ta = 25°C)

Propagation Delay (TPLH / TPHL)

- NJU7725x 42ns / 35ns - NJU7726x 125ns / 32ns

• Rail-to-Rail Common-Mode Input Voltage Range

0.2V beyond Supply Rails

■ Dynamic Transient Stabilizer TM

- Rail-to-Rail Input with no propagation delay fluctuation

• Push-Pull Output (NJU7725x)

• Open-Drain Output (NJU7726x)

Output Drive Current

- Sink ( $V_0 = 1V$ ) 40mA - Source ( $V_0 = 4V$ , NJU7725x) 37mA

Supply Current
 Supply Voltage
 140µA/ch
 2.7V to 5.5V

• Operating Temperature -40°C to 125°C

• Lead-less Small Package

DFN6-G1 (ESON6-G1) (1.6 x 1.6 mm) DFN8-U1 (ESON8-U1) (2.0 x 2.0 mm)

Standard Small Package

SOT-23-5, SC-88A MSOP8 (VSP8)

#### **■ APPLICATIONS**

- Protection circuit for overvoltage detection, overcurrent detection, overheat detection, etc.
- Window comparators
- LED drivers
- Relay drivers
- Electronic and electrical equipment in general
- Voltage Level Translators

#### **■ DESCRIPTION**

The NJU7725x, NJU7726x series are Rail-to-Rail Input CMOS comparators featuring High-Speed. These comparators operate from 2.7V to 5.5V and low supply current of 140 $\mu$ A/ch. typ. This feature is suitable for battery powered application.

NJU7725x, NJU7726x series features the newly developed circuit technology Dynamic Transient Stabilizer <sup>TM</sup> realizes full swing input with suppressed fluctuation of propagation delay time. In addition, the common mode input voltage range that exceeds the power supply voltage range is specified, and voltage detection near the power supply voltage is supported.

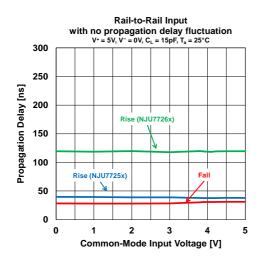
NJU7725x, NJU7726x series are available in ultra-small, leadless package measuring 1.6 mm x 1.6 mm (DFN6) and 2.0 mm x 2.0 mm (DFN8), and industrial standard leaded packages SOT-23-5, SC-88A, and MSOP8 (VSP8).

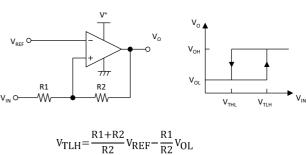
Dynamic Transient Stabilizer  $^{\text{TM}}$ ; It is a circuit technology that suppresses fluctuations in propagation delay time even if the reference voltage for voltage detection fluctuates.

#### NJU772xx Series Comparator Lineup

Product Name	Output	Supply Current	Propagation Delay
NJU7721x	Push-Pull	0.6µA∕ch	9.8µs
NJU7722x	Open-Drain	0.6µA∕ch	9.8µs
NJU7723x	Push-Pull	6.0µA/ch	780ns
NJU7724x	Open-Drain	6.0µA/ch	840ns
NJU7725x	Push-Pull	140µA/ch	42ns
NJU7726x	Open-Drain	140µA/ch	125ns

# ■ TYPICAL CHARACTERISTICS AND APPLICATION





$$\begin{aligned} & V_{TLH} \! = \! \frac{R1 \! + \! R2}{R2} V_{REF} \! - \! \frac{R1}{R2} V_{OL} \\ & V_{THL} \! = \! \frac{R1 \! + \! R2}{R2} V_{REF} \! - \! \frac{R1}{R2} V_{OH} \end{aligned}$$

Noninverting Comparator with Hysteresis

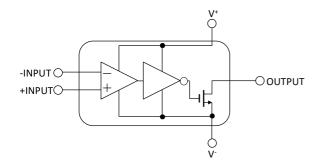
# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

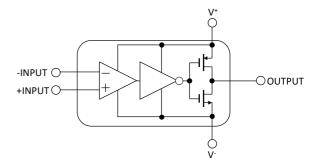
# **■ PIN CONFIGURATIONS**

PRODUCT NAME	NJU77250F	NJU77250F3	NJU77251F	NJU77251F3	NJU77251KG1	
PACKAGE	SOT-23-5	SC-88A	SOT-23-5	SC-88A	ESON6-G1	
Pin Functions	OUTPUT 1 5 V+  V- 2 +INPUT 3 -INPUT		(Top View) +INPUT 1 5 V+ V- 2 4 OUTPUT		(Top View)  V+ 1	
PRODUCT NAME	NJU77260F	NJU77260F3	NJU77261F	NJU77261F3	NJU77261KG1	
PACKAGE	SOT-23-5	SC-88A	SOT-23-5	SC-88A	ESON6-G1	
Pin Functions	OUTPUT 1 5 V*  V· 2 + 1NPUT 3 4 - INPUT		(Top V +INPUT 1 V· 2 -INPUT 3	/iew) 5 V+ 4 OUTPUT	(Top View)  V+ 1	
PRODUCT NAME		NJU77252R NJU77262R			NJU77252KU1 NJU77262KU1	
Package		VSP8			ESON8-U1	
Pin Functions	(Top View)  A OUTPUT 1			A +INPUT	(Top View)  10  10  10  10  10  10  10  10  10  1	



## **■ BLOCK DIAGRAM**

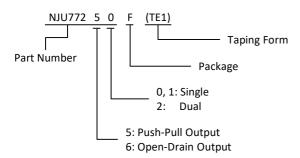




Open-Drain Output

Push-Pull Output

## **■ PRODUCT NAME INFORMATION**



#### **■ ORDERING INFORMATION**

PRODUCT NAME	PACKAGE	RoHS	HALOGEN- FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs)
NJU77250F (TE1)	SOT-23-5	Yes	Yes	Sn2Bi	1S	15	3000
NJU77250F3 (TE1)	SC-88A	Yes	Yes	Sn2Bi	F5	7.5	3000
NJU77251F (TE1)	SOT-23-5	Yes	Yes	Sn2Bi	1U	15	3000
NJU77251F3 (TE1)	SC-88A	Yes	Yes	Sn2Bi	F6	7.5	3000
NJU77251KG1 (TE3)	DFN6-G1 (ESON6-G1)	Yes	Yes	Sn2Bi	77251	3.5	3000
NJU77260F (TE1)	SOT-23-5	Yes	Yes	Sn2Bi	-	15	3000
NJU77260F3 (TE1)	SC-88A	Yes	Yes	Sn2Bi	-	7.5	3000
NJU77261F (TE1)	SOT-23-5	Yes	Yes	Sn2Bi	-	15	3000
NJU77261F3 (TE1)	SC-88A	Yes	Yes	Sn2Bi	-	7.5	3000
NJU77261KG1 (TE3)	DFN6-G1 (ESON6-G1)	Yes	Yes	Sn2Bi	77261	3.5	3000
NJU77252R (TE1)	MSOP8 (VSP8)	Yes	Yes	Sn2Bi	77252	21	2000
NJU77252KU1 (TE3)	DFN8-U1 (ESON8-U1)	Yes	Yes	Sn2Bi	77252	5.3	3000
NJU77262R (TE1)	MSOP8 (VSP8)	Yes	Yes	Sn2Bi	77262	21	2000
NJU77262KU1 (TE3)	DFN8-U1 (ESON8-U1)	Yes	Yes	Sn2Bi	77262	5.3	3000

#### PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

#### ■ ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V+ - V-	7	V
Input Voltage (1)	V <sub>IN</sub>	V <sup>-</sup> - 0.3 to V <sup>+</sup> + 0.3	V
Input Current (1)	lin	10	mA
Differential Input Voltage (2)	V <sub>ID</sub>	±7	V
Output Terminal Input Voltage (3)	Vo	V <sup>-</sup> - 0.3 to V <sup>+</sup> + 0.3	V
Power Dissipation (T <sub>a</sub> = 25°C)		2-Layer / 4-Layer (4)	
SOT-23-5 SC-88A DFN6-G1 (ESON6-G1) MSOP8 (VSP8) DFN8-U1 (ESON8-U1)	Po	480 / 650 360 / 490 330 / 1200 <sup>(5)</sup> 500 / 660 450 / 1200 <sup>(5)</sup>	mW
Storage Temperature	T <sub>stg</sub>	-65 to 150	°C
Junction Temperature	Tj	150	°C

<sup>(1)</sup> Input voltages outside the supply voltage will be clamped by ESD protection diodes. If the input voltage exceeds the supply voltage, the current must be limited 10 mA or less by using a restriction resistance.

- (2) Differential voltage is the voltage difference between +INPUT and -INPUT. The absolute maximum input voltage is limited at 7V.
- (3) The output terminal input voltage is limited at 7V.
- (4) 2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).
  4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4), internal Cu area: 74.2 mm × 74.2 mm.
- (5) 2-Layer: Mounted on glass epoxy board (101.5 mm × 114.5 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4) with exposed pad. 4-Layer: Mounted on glass epoxy board (101.5 mm × 114.5 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4) with exposed pad. (For 4-layer: Applying 99.5 mm × 99.5 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

#### **■ RECOMMENDED OPERATING CONDITIONS**

PARAMETER	SYMBOL	CONDITIONS	VALUE	UNIT
Supply Voltage	V+ - V-		2.7 to 5.5	V
Input Voltage (8)	VIN		V <sup>-</sup> - 0.2 to V <sup>+</sup> + 0.2 (MAX 5.5)	V
Output Terminal Input Voltage	Vo	NJU7726x	$V^ 0.2$ to $V^- + 5.5$	V
Operating Temperature	Topr		-40 to 125	°C

# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

■ ELECTRICAL CHARACTERISTICS (V<sup>+</sup> = 5V, V<sup>-</sup> = 0V, R<sub>L</sub> = Open, T<sub>a</sub> = 25°C, unless otherwise noted.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT CHARACTERISTICS			•			
Input Offset Voltage	V <sub>IO</sub>	V <sub>COM</sub> = -0.2V V <sub>COM</sub> = 5.2V	-	1 1	7 9	mV mV
Input Bias Current	lΒ		-	1	-	pА
Input Offset Current	lıo		-	1	-	рА
Common-Mode Input Voltage Range	V <sub>ICM</sub>	CMR ≥ 55dB	-0.2	-	5.2	V
Common-Mode Rejection Ratio	CMR	V <sub>ICM</sub> = -0.2V to 5.2V	55	70	-	dB
OUTPUT CHARACTERISTICS	•		<b>.</b>		•	•
High-level Output Voltage (NJU7725x)	Vон	Isource = 4mA	4.8	4.9	-	V
Low-level Output Voltage	VoL	Isink = 4mA	-	0.1	0.2	V
Output Leakage Current (NJU7726x)	ILEAK	V <sub>0</sub> = 5V	-	1	700	nA
Output Short-Circuit Current (NJU7725x)	I <sub>SC</sub>	I <sub>SOURCE</sub> , V <sub>O</sub> = 0V		85	-	mA
Output Short-Circuit Current	Isc	I <sub>SINK</sub> , V <sub>O</sub> = 5V		65	-	mA
POWER SUPPLY						
Supply Current per Amplifier	lauran v	V <sub>COM</sub> = -0.2V	-	140	210	μA
Supply Current per Ampliner	ISUPPLY	V <sub>COM</sub> = 5.2V	-	200	300	μA
Supply Voltage Rejection Ratio	SVR	$V^+ = 2.7V$ to 5.5V	60	85	-	dB
<b>Transient Response</b> ( $R_L = 5.1 k\Omega$ , $C_L = (NJU7725x)$	= 15pF, Overd	drive = 100mV)				
Propagation Delay (Low to High)	t <sub>PLH</sub>		-	42	-	μs
Propagation Delay (High to Low)	t <sub>PHL</sub>		-	35	-	μs
Rise Time	t⊤∟H		-	4.0	-	ns
Fall Time	tTHL		-	3.5	-	ns
(NJU7726x)	•					
Propagation Delay (Low to High)	t <sub>PLH</sub>		-	125	-	μs
Propagation Delay (High to Low)	t <sub>PHL</sub>		-	32	-	μs
Rise Time	tтьн		-	250	-	ns
Fall Time	t <sub>THL</sub>		-	2	-	ns

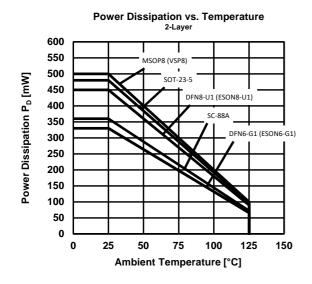


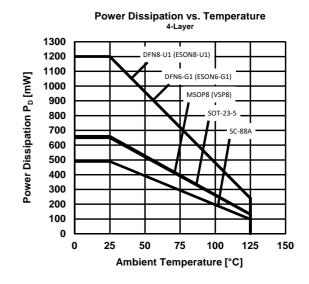
#### **■ THERMAL CHARACTERISTICS**

PACKAGE	SYMBOL	VALUE	UNIT
Junction-to-Ambient Thermal Resistance		2-Layer / 4-Layer <sup>(6)</sup>	
SOT-23-5 SC-88A DFN6-G1 (ESON6-G1) MSOP8 (VSP8) DFN8-U1 (ESON8-U1)	θ <sub>ja</sub>	260 / 192 347 / 255 379 / 104 <sup>(7)</sup> 250 / 189 278 / 104 <sup>(7)</sup>	°C/W
Junction-to-Top of Package Characterization Parameter  SOT-23-5 SC-88A DFN6-G1 (ESON6-G1) MSOP8 (VSP8) DFN8-U1 (ESON8-U1)	Ψįt	2-Layer / 4-Layer <sup>(6)</sup> 67 / 58 91 / 73 64 / 26 <sup>(7)</sup> 62 / 53 42 / 25 <sup>(7)</sup>	°C/W

<sup>(6) 2-</sup>Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).
4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4), internal Cu area: 74.2 mm × 74.2 mm.

## ■ POWER DISSIPATION vs. AMBIENT TEMPERATURE

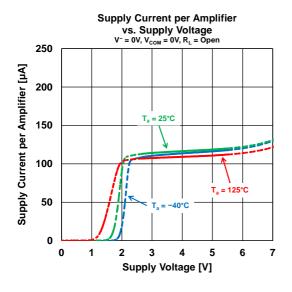


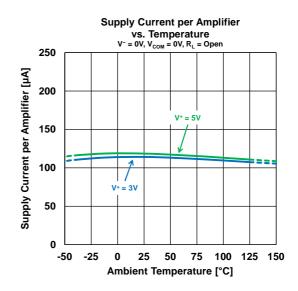


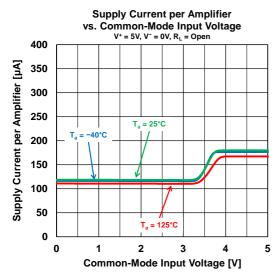
<sup>(7) 2-</sup>Layer: Mounted on glass epoxy board (101.5 mm × 114.5 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4) with exposed pad. 4-Layer: Mounted on glass epoxy board (101.5 mm × 114.5 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4) with exposed pad. (For 4-layer: Applying 99.5 mm × 99.5 mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5.)

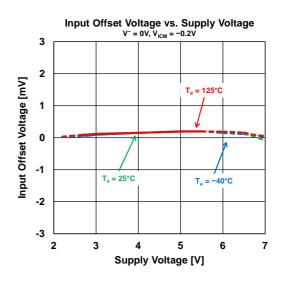


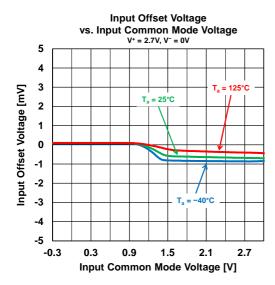
#### **■ TYPICAL CHARACTERISTICS**

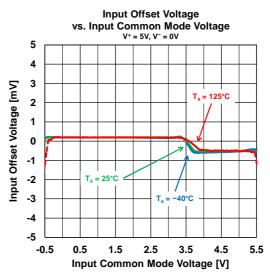






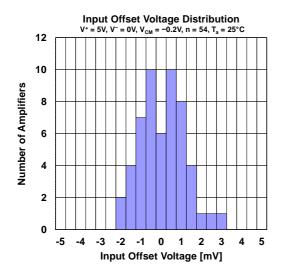


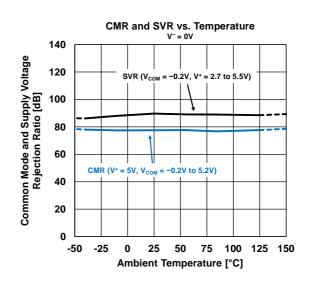


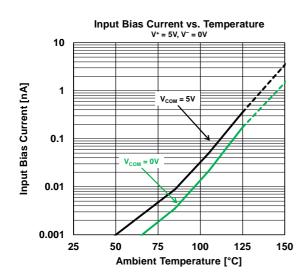


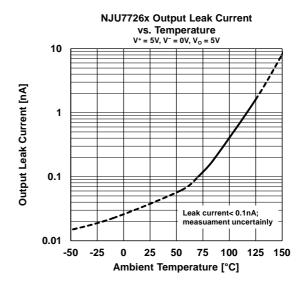


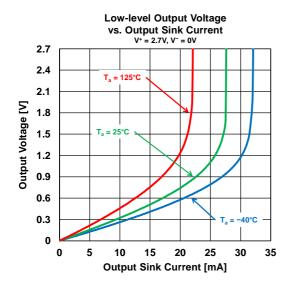
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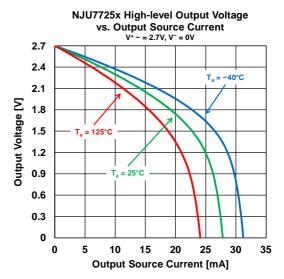






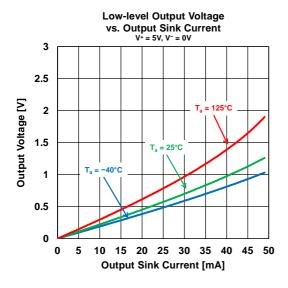


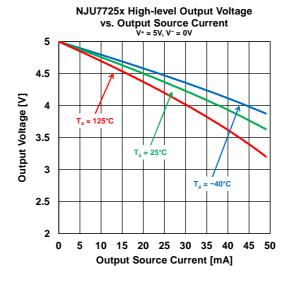


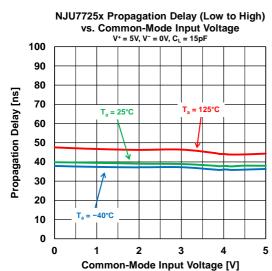


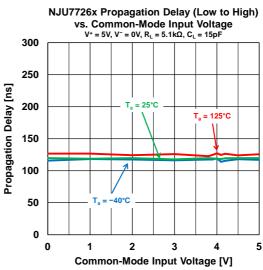


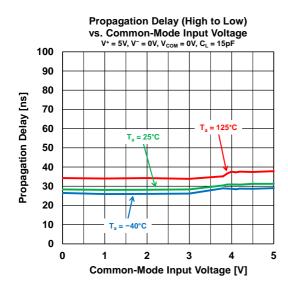
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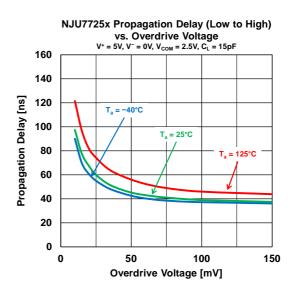








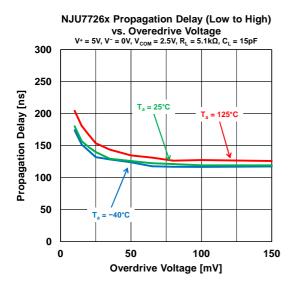


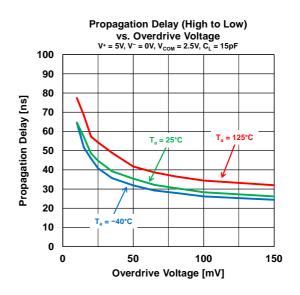


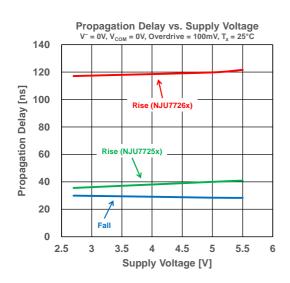
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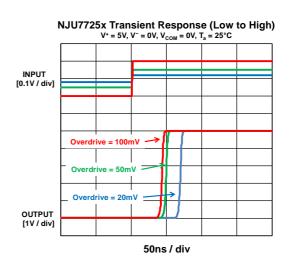


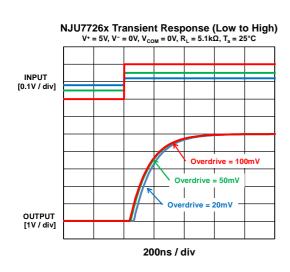
#### **■ TYPICAL CHARACTERISTICS**

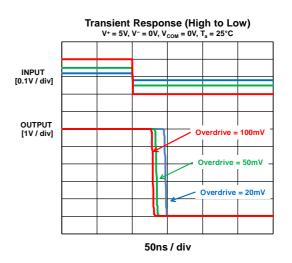










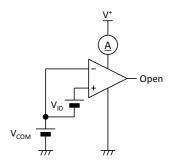




# **■ TEST CIRCUITS**

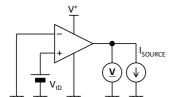
• I<sub>SUPPLY</sub>

 $V_{ID} = 100 \text{mV}$ 



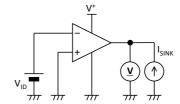
Voh

 $V_{ID} = 100 \text{mV}$ 



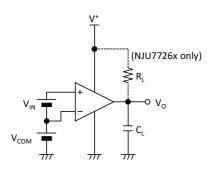
• Vol

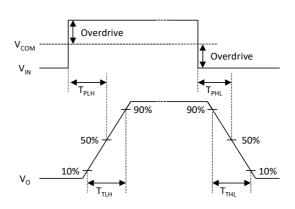
 $V_{ID} = 100 \text{mV}$ 



# • Propagation Delay

 $R_L = 5.1k\Omega$ ,  $V_{COM} = 0V$ ,  $V^+$ ,  $C_L = 15pF$ 





#### **■ APPLICATION NOTE**

## Single and Dual Supply Voltage Operation

The NJU7725x, NJU7726x series works with both single supply and dual supply when the voltage supplied is between V<sup>+</sup> and V<sup>-</sup>. These comparators operate from single 2.7V to 5.5V supply and dual  $\pm 1.35$ V to  $\pm 2.75$ V supply. The power supply pin should have bypass capacitor (i.e.  $0.1\mu F)$ .

#### Input Voltage

The NJU7725x, NJU7726x series are Rail-to-Rail input comparators. The common mode input voltage range is V $^-$ 0.2V to V $^+$ +0.2V, and the differential input voltage can be any voltage within supply voltage. No phase inversion of the comparator output occurs when the input range of V $^-$ -0.2V to V $^+$ +0.2V.

Inputs of the NJU7725x, NJU7726x series are protected by ESD diodes (shown in Figure 1) that will conduct if the input voltages exceed the power supplies by more than approximately 300mV. Momentary voltages greater than 300mV beyond the power supply, inputs can be tolerated if the current is limited to 10mA.

Figure 2 is simple accomplished with an input resistor. If the input voltage exceeds the supply voltage, the input current must be limited 10mA or less by using a restriction  $R_{\text{LIMIT}}$  as shown in figure 2.

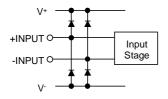


Figure 1. Simplified Schematic

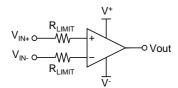


Figure 2. Input Current Protection for Voltages exceeding the Supply Voltage.

#### **Output Voltage**

Ver.0.2

The NJU7725x series features a push-pull output. The output logic level is the same as the supply rail. The circuit can be simplified without the need for an external pull-up resistor.

The NJU7726x series has an open drain output. It can be pulled up to an external power supply up to  $V^- + 5.5V$  independent of supply voltage. It can be applied to window comparators and logic level converter.

## Dynamic Transient Stabilizer ™

The NJU7725x and NJU7726x series use the new circuit technology Dynamic Transient Stabilizer <sup>TM</sup> to realize a rail-to-rail input that suppresses fluctuations in propagation delay.

A general rail-to-rail input comparator operates within the supply rails, but when the input signal level is close to the supply voltage, the propagation delay will decrease and may not be as designed.

Figure 3 compares the NJU7725x and NJU7726x with a conventional rail-to-rail input comparators. Conventional comparators have a delay of 20 ns close to the supply voltage. This change in propagation delay requires a review of the design margin, which increases the design period.

By using the NJU7725x and NJU7726x series with Dynamic Transient Stabilizer  $^{\text{TM}}$ , stable response can be obtained in any voltage within supply voltage.

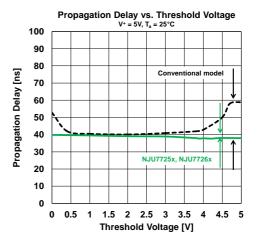
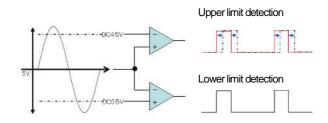


Figure 3. Propagation delay vs. Threshold Voltage

Figure 4 shows a window comparator circuit using the NJU7726x series. Even if the threshold setting is set near the power supply voltage, stable operation can be performed without delay in response time.



In conventional comparators, the upper limit detection was changed. -> Lower limit detection and upper limit detection are different.

Figure 4. Level detection circuit using window comparator

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## **■ APPLICATION NOTE**

## **Terminating unused comparators**

Examples of common methods of terminating an uncommitted comparator are shown in Figure 5. Improper termination can be result increase supply current, heating and noise in comparators.

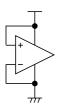


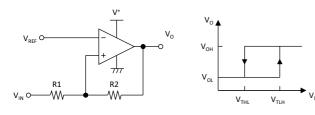
Figure 5. Terminating unused comparators

## **External Hysteresis**

The comparator can change the threshold by using positive feedback. The difference in threshold voltage is called hysteresis, which can improve noise immunity and operation for low-speed signals.

#### **Noninverting Comparator with Hysteresis**

Figure 6 shows a hysteresis comparator circuit with two resistors. Assuming that the threshold at which the comparator output is Low-High is  $V_{TLH}$  and the threshold at which the comparator output is High-Low is  $V_{THL}$ , to achieve the following hysteresis are below.



$$V_{TLH} = \frac{R1 + R2}{R2} V_{REF} - \frac{R1}{R2} V_{OL}$$

$$V_{THL} = \frac{R1 + R2}{R2} V_{REF} - \frac{R1}{R2} V_{OH}$$

Figure 6. Noninverting Comparator with Hysteresis

## **Inverting Comparator with Hysteresis**

Igure7 shows a hysteresis comparator circuit with three resistors.

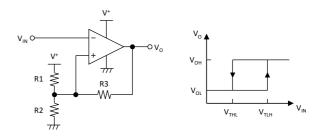
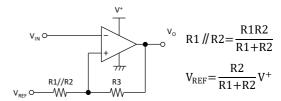


Figure 7. Inverting Comparator with Hysteresis

If R1 and R2 of the circuit in Figure 7 are represented by equivalent resistors, the circuit will be as shown in Figure 8. Since this circuit is the same as the noninverting hysteresis comparator,  $V_{TLH}$  and  $V_{THL}$  can be calculated by rearranging the equations.



$$\begin{split} V_{TLH} &= \frac{R1 \, / \! / \, R2}{R1 \, / \! / \, R2 + R3} \, V_{REF} + \frac{R1 \, / \! / \, R2}{R1 \, / \! / \, R2 + R3} \, V_{OL} \\ V_{THL} &= \frac{R1 \, / \! / \, R2}{R1 \, / \! / \, R2 + R3} \, V_{REF} + \frac{R1 \, / \! / \, R2}{R1 \, / \! / \, R2 + R3} \, V_{OH} \end{split}$$

Figure 8. Noninverting hysteresis comparator as equivalent circuits

# ■ APPLICATION NOTE

## **Window Comparator**

By using the open drain type NJU7726x in parallel, it is achieve to detect whether the signal is between two reference voltages. This circuit is commonly called a window comparator and can be used for monitoring the reference voltage and monitoring abnormal voltages such as signal voltage drop or overvoltage.

Figure 9 shows a simple window comparator circuit. The comparator output  $V_0$  is High only when  $V_{\text{IN}}$  is between  $V_{\text{REF1}}$  and  $V_{\text{REF2}}$ , and Low otherwise. If chattering occurs during the output shift period, connect capacitors in parallel with R1 and R3.

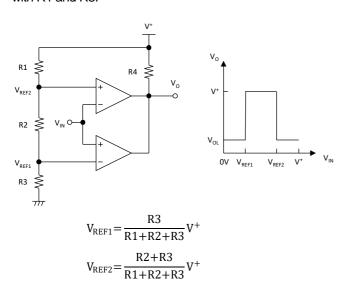


Figure 9. Window Comparator with NJU7726x

#### Example)

Assuming V+ = 3.3V, R1 = R2 = R3 = 1M $\Omega$ , R4 = 10k $\Omega$ , the thresholds from the formula in Figure 9 are V<sub>REF1</sub> = 1.1V, V<sub>REF2</sub> = 2.2V.

 $V_O$  is Low when  $V_{IN}$  < 1.1V or  $V_{IN}$  > 2.2V, and  $V_O$  is High when  $V_{IN}$  is between1.1V and 2.2V (Figure 10).

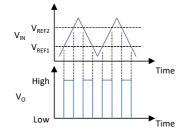


Figure 10. Window comparator output results

## **Square Wave Oscillator**

Figure 11 shows a simple square wave oscillator circuit. It can be used to digital circuits such as microcomputers, oscillation circuits, timing waveforms, and driver circuits for electronic buzzers.

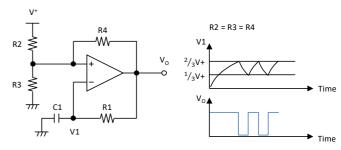


Figure 11. Square Wave Oscillator

When R2 = R3, the oscillator circuit has 50% duty, and the oscillation frequency is as follows.

$$f = \frac{1}{2R1C1 \ln \left(1 + \frac{R4}{R3}\right)} [Hz]$$

$$R2 = R3$$

R4 sets the threshold of the comparator that switches between charging and discharging to C1. If R2 = R3 = R4, the oscillation frequency is as follows.

$$f = \frac{1}{2R1C1 \ln 2} [Hz]$$
  
R2=R3=R4

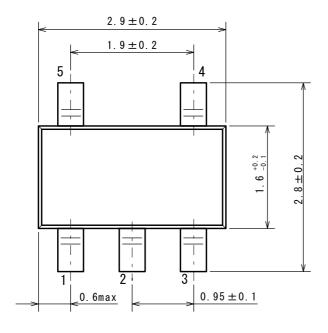


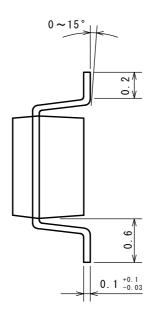
# **SOT-23-5**

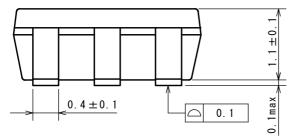
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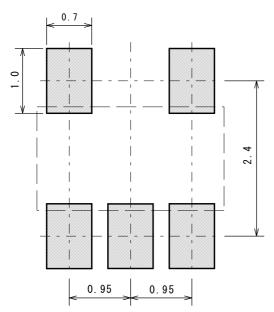
Unit: mm

# **■ PACKAGE DIMENSIONS**









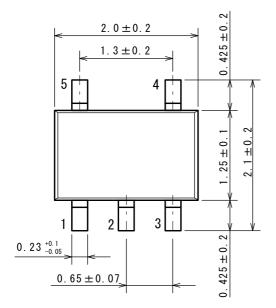


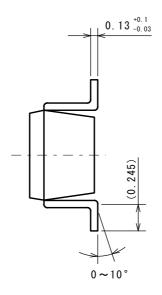
# **SC-88A**

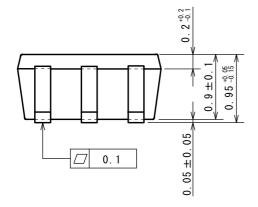
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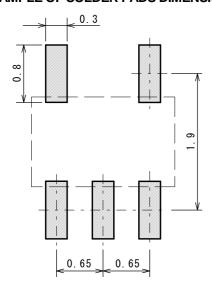
Unit: mm

# **■ PACKAGE DIMENSIONS**









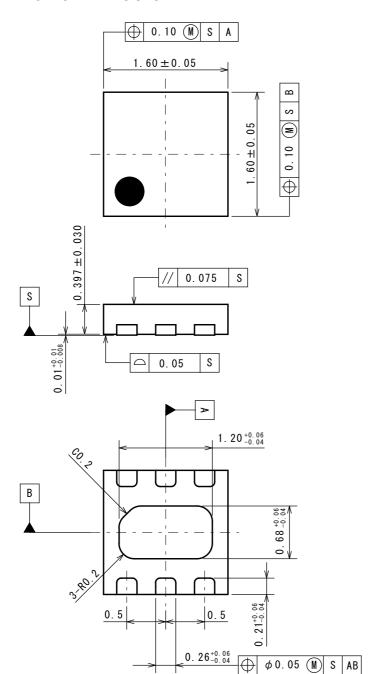


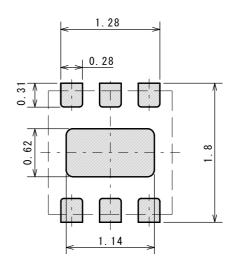
# DFN6-G1

# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

Unit: mm

# **■ PACKAGE DIMENSIONS**





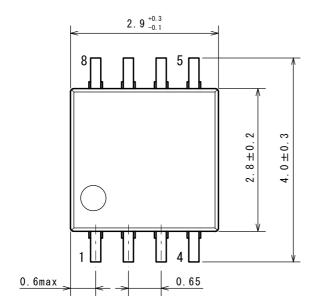


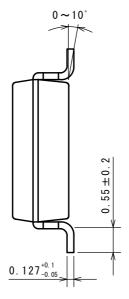
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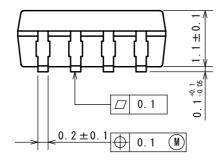
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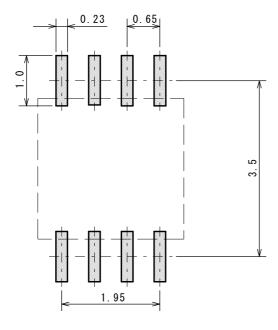
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# **■ PACKAGE DIMENSIONS**











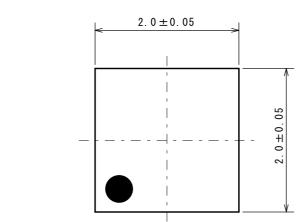
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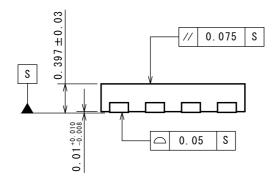
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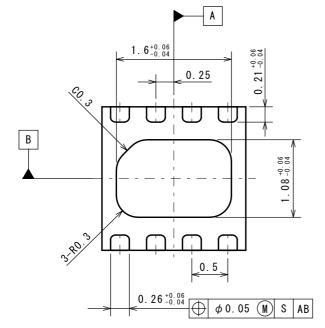
**■ EXAMPLE OF SOLDER PADS DIMENSIONS** 

Unit: mm

# **■ PACKAGE DIMENSIONS**







# 0.5

1.78

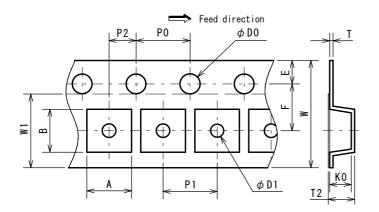
# **SOT-23-5**

# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

# **■ PACKING SPEC**

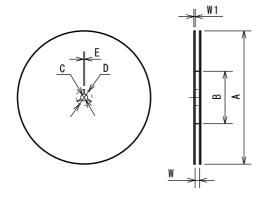
# Unit: mm

## **TAPING DIMENSIONS**



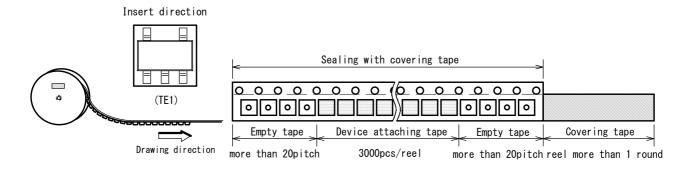
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Α	3.3±0.1	BOTTOM DIMENSION
В	3.2±0.1	BOTTOM DIMENSION
D0	1. 55	
D1	1. 05	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	$2.0 \pm 0.05$	
T	$0.25 \pm 0.05$	
T2	1. 82	
K0	1.5±0.1	
W	$8.0 \pm 0.3$	
W1	5. 5	THICKNESS 0.1MAX

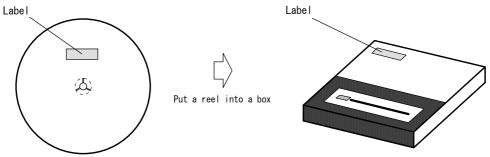
#### **REEL DIMENSIONS**



SYMBOL	DIMENSION		
Α	$\phi$ 180 ± 1		
В	φ 60±1		
С	φ 13±0.2		
D	φ 21±0.8		
Е	2±0.5		
W	9±0.5		
W1	1.2±0.2		

#### **TAPING STATE**





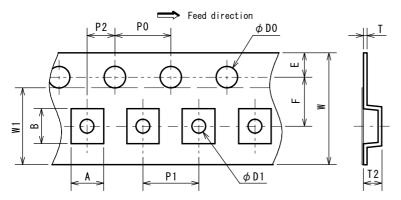
# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

# SC-88A

# ■ PACKING SPEC

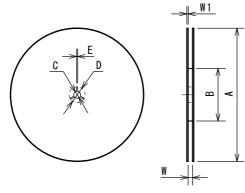
# Unit: mm

## **TAPING DIMENSIONS**



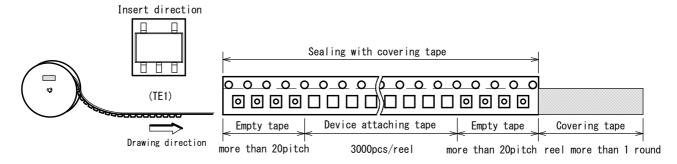
SYMBOL	DIMENSION	REMARKS
A	2.3±0.1	BOTTOM DIMENSION
В	2.5±0.1	BOTTOM DIMENSION
D0	1.55±0.05	
D1	1.05±0.05	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	2.0±0.05	
T	0.25±0.05	
T2	1.3±0.1	
W	8.0±0.2	
W1	5. 5	THICKNESS 0.1max

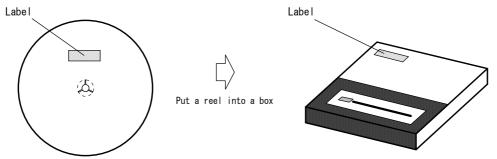
#### **REEL DIMENSIONS**



SYMBOL	DIMENSION	
Α	$\phi$ 180 ± 1	
В	$\phi$ 60±1	
С	φ 13±0.2	
D	$\phi$ 21 ± 0.8	
Ε	2±0.5	
W	9±0.5	
W1	1.2±0.2	

## **TAPING STATE**





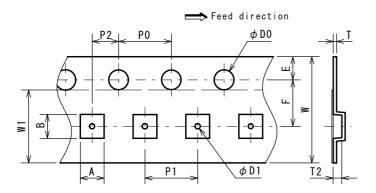
# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

# DFN6-G1

# **■ PACKING SPEC**

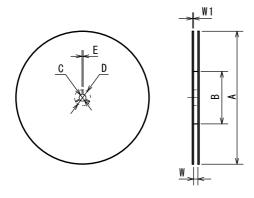
Unit: mm

## **TAPING DIMENSIONS**



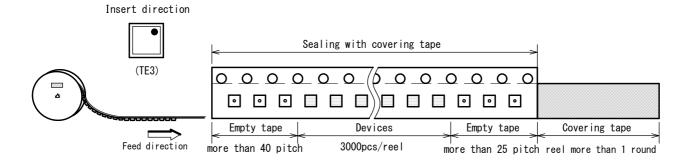
SYMBOL	DIMENSION	REMARKS
A	1.85±0.05	BOTTOM DIMENSION
В	1.85±0.05	BOTTOM DIMENSION
D0	1. 5 <sup>+0. 1</sup>	
D1	0.5±0.1	
E	1.75±0.1	
F	$3.5 \pm 0.05$	
P0	4.0±0.1	
P1	4.0±0.1	
P2	$2.0\pm0.05$	
T	$0.25 \pm 0.05$	
T2	$0.65 \pm 0.05$	
W	8.0±0.2	
W1	5. 5	THICKNESS 0.1max

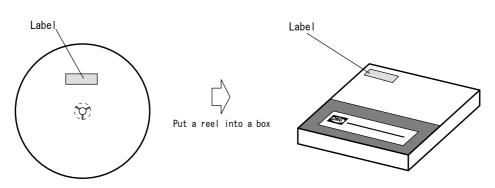
## **REEL DIMENSIONS**



SYMBOL	DIMENSION
Α	$\phi$ 180 $^{0}_{-1.5}$
В	φ 60 <sup>+1</sup> <sub>0</sub>
С	φ 13±0.2
D	φ 21±0.8
E	2±0.5
W	9 +0.3
W1	1. 2

#### **TAPING STATE**





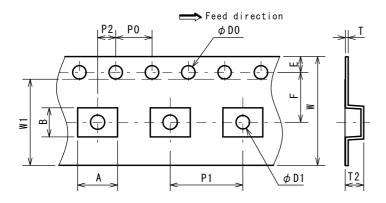
# MSOP8 (VSP8) MEET JEDEC MO-187-DA

# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

# **■ PACKING SPEC**

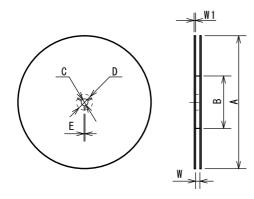
# Unit: mm

## **TAPING DIMENSIONS**



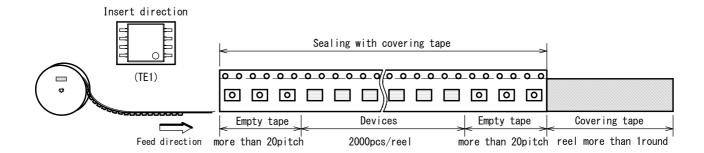
SYMBOL	DIMENSION	REMARKS
Α	4. 4	BOTTOM DIMENSION
В	3. 2	BOTTOM DIMENSION
D0	1. 5 <sup>+0. 1</sup>	
D1	1. 5 <sup>+0.1</sup>	
Е	1.75±0.1	
F	5.5±0.05	
P0	4.0±0.1	
P1	8.0±0.1	
P2	$2.0\pm0.05$	
T	$0.30 \pm 0.05$	
T2	2.0 (MAX.)	
W	$12.0\pm0.3$	
W1	9. 5	THICKNESS 0.1max

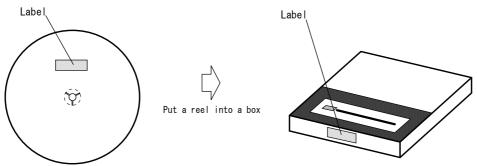
## **REEL DIMENSIONS**



SYMBOL	DIMENSION	
Α	$\phi 254 \pm 2$	
В	φ100±1	
С	φ 13±0.2	
D	$\phi$ 21 ± 0.8	
Е	2±0.5	
W	13.5±0.5	
W1	2.0±0.2	

#### **TAPING STATE**





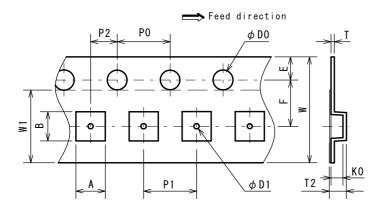
# PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

# **DFN8-U1**

# **■ PACKING SPEC**

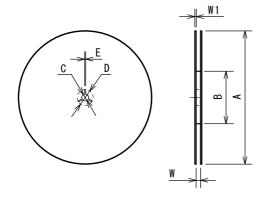
# Unit: mm

## **TAPING DIMENSIONS**



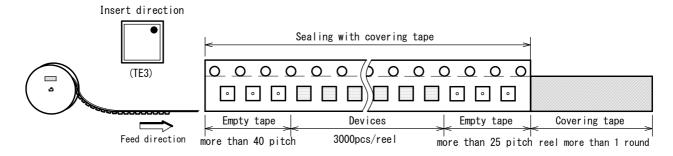
SYMBOL	DIMENSION	REMARKS
Α	2. 25±0. 05	BOTTOM DIMENSION
В	2. 25±0. 05	BOTTOM DIMENSION
D0	1. 5 +0.1	
D1	0.5±0.1	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	2.0±0.05	
T	$0.25 \pm 0.05$	
T2	1.00±0.07	
K0	0.65±0.05	
W	8.0±0.2	
W1	5. 5	THICKNESS 0.1max

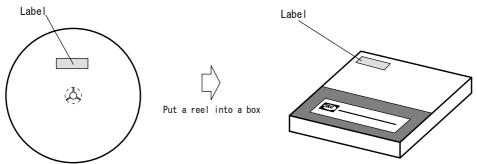
#### **REEL DIMENSIONS**



SYMBOL	DIMENSION
Α	$\phi$ 180 $_{-1.5}^{0}$
В	φ 60 <sup>+1</sup> <sub>0</sub>
С	φ 13±0.2
D	$\phi$ 21 ± 0.8
Е	2±0.5
W	9 +0.3
W1	1. 2

#### **TAPING STATE**

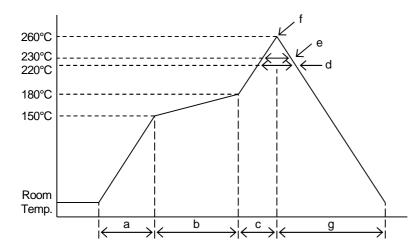






# ■ RECOMMENDED MOUNTING METHOD

# **INFRARED REFLOW SOLDERING PROFILE**



а	Temperature ramping rate	1 to 4°C/s
۶	Pre-heating temperature	150 to 180°C
b	Pre-heating time	60 to 120s
С	Temperature ramp rate 1 to 4°C/s	
d	220°C or higher time	shorter than 60s
е	230°C or higher time	shorter than 40s
f	Peak temperature	lower than 260°C
g	Temperature ramping rate	1 to 6°C/s

The temperature indicates at the surface of mold package.

# **■ REVISION HISTORY**

DATE	REVISION	CHANGES
August 31, 2020	Ver.0.0	Initial Release
August 19, 2021	Ver.0.1	Added NJU7726x series Added Application Note.
September 22, 2021	Ver.0.2	Updated Descriptions.

#### PRELIMINARY SPECIFICATIONS SUBJECT TO CHANGE

## [CAUTION]

- NJR strives to produce reliable and high quality semiconductors. NJR's semiconductors are intended for specific applications and require proper maintenance and handling. To enhance the performance and service of NJR's semiconductors, the devices, machinery or equipment into which they are integrated should undergo preventative maintenance and inspection at regularly scheduled intervals. Failure to properly maintain equipment and machinery incorporating these products can result in catastrophic system failures
- The specifications on this datasheet are only given for information without any guarantee as regards either mistakes or omissions.
  The application circuits in this datasheet are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial property rights.
   All other trademarks mentioned herein are the property of their respective companies.
- 3. To ensure the highest levels of reliability, NJR products must always be properly handled.

  The introduction of external contaminants (e.g. dust, oil or cosmetics) can result in failures of semiconductor products.
- NJR offers a variety of semiconductor products intended for particular applications. It is important that you select the proper component for your intended application. You may contact NJR's Sale's Office if you are uncertain about the products listed in this datasheet.
- 5. Special care is required in designing devices, machinery or equipment which demand high levels of reliability. This is particularly important when designing critical components or systems whose failure can foreseeably result in situations that could adversely affect health or safety. In designing such critical devices, equipment or machinery, careful consideration should be given to amongst other things, their safety design, fail-safe design, back-up and redundancy systems, and diffusion design.
- The products listed in this datasheet may not be appropriate for use in certain equipment where reliability is critical or where the products may be subjected to extreme conditions. You should consult our sales office before using the products in any of the following types of equipment.
  - · Aerospace Equipment
  - · Equipment Used in the Deep Sea
  - · Power Generator Control Equipment (Nuclear, steam, hydraulic, etc.)
  - · Life Maintenance Medical Equipment
  - · Fire Alarms / Intruder Detectors
  - · Vehicle Control Equipment (Automobile, airplane, railroad, ship, etc.)
  - · Various Safety Devices
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- 8. Warning for handling Gallium and Arsenic (GaAs) Products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 9. The product specifications and descriptions listed in this datasheet are subject to change at any time, without notice.

